

# AMD Athlon™ X2

## Dual-Core Processor

### Product Data Sheet



- **Compatible with Existing 32-Bit Code Base**
  - Including support for SSE, SSE2, SSE3, MMX™, 3DNow!™ technology and legacy x86 instructions
  - Runs existing operating systems and drivers
  - Local APIC on-chip
- **AMD64 Technology**
  - AMD64 technology instruction set extensions
  - 64-bit integer registers, 48-bit virtual addresses, 40-bit physical addresses
  - Eight additional 64-bit integer registers (16 total)
  - Eight additional 128-bit SSE/SSE2/SSE3 registers (16 total)
- **Dual-Core Architecture**
  - Discrete L1 and L2 cache structures for each core
- **HyperTransport™ Technology to I/O Devices**
  - One 16-bit link supporting speeds up to 1 GHz (2000 MT/s) or 4 Gigabytes/s in each direction
- **64-Kbyte 2-Way Associative ECC-Protected L1 Data Caches**
  - Two 64-bit operations per cycle, 3-cycle latency
- **64-Kbyte 2-Way Associative Parity-Protected L1 Instruction Caches**
  - With advanced branch prediction
- **16-Way Associative ECC-Protected L2 Caches**
  - Exclusive cache architecture—storage in addition to L1 caches
  - Up to 1 Mbyte per L2 cache
- **Machine Check Architecture**
  - Includes hardware scrubbing of major ECC-protected arrays
- **Power Management**
  - Multiple low-power states including C1E
  - System Management Mode (SMM)
  - ACPI-compliant, including support for processor performance states

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## Socket AM2 Specific Features

- **Refer to the *Socket AM2 Processor Functional Data Sheet*, order# 31117, for functional and mechanical details of socket AM2 processors.**
- **Refer to the *AMD NPT 0Fh Family Processor Electrical Data Sheet*, order# 31119, for electrical details of socket AM2 processors.**
- **Electrical Interfaces**
  - HyperTransport™ technology: LVDS-like differential, unidirectional
  - DDR2 SDRAM: SSTL\_1.8 per JEDEC specification
  - Clock, reset, and test signals also use DDR2 SDRAM-like electrical specifications
- **Packaging**
  - Lidded micro PGA
  - 31 x 31 grid array
  - 1.27-mm pin pitch
  - Compliant with RoHS (EU Directive 2002/95/EC) with lead used only in small amounts in specifically exempted applications
- **Integrated Memory Controller**
  - Low-latency, high-bandwidth
  - 144-bit DDR2 SDRAM controller operating at up to 400 MHz
  - Supports up to four unbuffered DIMMs
  - ECC checking with double-bit detect and single-bit correct

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## Revision History

Date	Revision	Description
May 2007	3.00	Initial public release.

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